

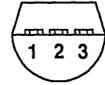
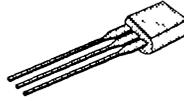
## PRODUCT SUMMARY

PART NUMBER	$V_{(BR)DSS}$ (V)	$r_{DS(ON)}$ ( $\Omega$ )	$I_D$ (A)	PACKAGE
VN1706L	170	6	0.22	TO-92
VN1706M	170	6	0.25	TO-237

Performance Curves: VNDB24 (See Section 7)

TO-92

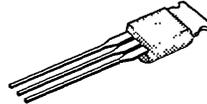
BOTTOM VIEW



1 SOURCE  
2 GATE  
3 DRAIN

TO-237

BOTTOM VIEW



1 SOURCE  
2 GATE  
3 DRAIN

## ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	VN1706L	VN1706M	UNITS
Drain-Source Voltage		$V_{DS}$	170	170	V
Gate-Source Voltage		$V_{GS}$	$\pm 30$	$\pm 30$	
Continuous Drain Current	$T_A = 25^\circ\text{C}$	$I_D$	0.22	0.25	A
	$T_A = 100^\circ\text{C}$		0.14	0.16	
Pulsed Drain Current <sup>1</sup>		$I_{DM}$	2.3	2.5	
Power Dissipation	$T_A = 25^\circ\text{C}$	$P_D$	0.8	1.0	W
	$T_A = 100^\circ\text{C}$		0.32	0.4	
Operating Junction and Storage Temperature		$T_J, T_{stg}$	-55 to 150		$^\circ\text{C}$
Lead Temperature (1/16" from case for 10 seconds)		$T_L$	300		

## THERMAL RESISTANCE

THERMAL RESISTANCE	SYMBOL	VN1706L	VN1706M	UNITS
Junction-to-Ambient	$R_{thJA}$	156	125	$^\circ\text{C}/\text{W}$

<sup>1</sup>Pulse width limited by maximum junction temperature

# VN1706L, VN1706M



ELECTRICAL CHARACTERISTICS <sup>1</sup>				LIMITS			
PARAMETER	SYMBOL	TEST CONDITIONS	TYP <sup>2</sup>	VN1706		UNIT	
				MIN	MAX		
<b>STATIC</b>							
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0\text{ V}, I_D = 100\ \mu\text{A}$	230	170		V	
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 1\text{ mA}$	1.4	0.8	2.0		
Gate-Body Leakage	$I_{GSS}$	$V_{DS} = 0\text{ V}$ $V_{GS} = \pm 15\text{ V}$ $T_J = 125^\circ\text{C}$	$\pm 1$ $\pm 5$		$\pm 100$ $\pm 500$	nA	
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 120\text{ V}$ $V_{GS} = 0\text{ V}$ $T_J = 125^\circ\text{C}$	0.01 1		10 500	$\mu\text{A}$	
On-State Drain Current <sup>3</sup>	$I_{D(ON)}$	$V_{DS} = 10\text{ V}, V_{GS} = 10\text{ V}$ $V_{GS} = 2.5\text{ V}, I_D = 0.1\text{ A}$	1.2 7.5	1		A	
Drain-Source On-Resistance <sup>3</sup>	$r_{DS(ON)}$	$V_{GS} = 10\text{ V}$ $I_D = 0.5\text{ V}$ $T_J = 125^\circ\text{C}$	5 10.8		6 14.8	$\Omega$	
Forward Transconductance <sup>3</sup>	$g_{FS}$	$V_{DS} = 10\text{ V}, I_D = 0.5\text{ A}$	530	300		mS	
Common Source Output Conductance <sup>3</sup>	$g_{OS}$	$V_{DS} = 7.5\text{ V}, I_D = 0.5\text{ A}$	475			$\mu\text{S}$	
<b>DYNAMIC</b>							
Input Capacitance	$C_{iss}$	$V_{DS} = 25\text{ V}$ $V_{GS} = 0\text{ V}$ $f = 1\text{ MHz}$	105		125	pF	
Output Capacitance	$C_{oss}$		25		50		
Reverse Transfer Capacitance	$C_{rss}$		5		20		
<b>SWITCHING</b>							
Turn-On Time	$t_{d(ON)}$	$V_{DD} = 60\text{ V}, R_L = 150\ \Omega$ $I_D = 0.1\text{ A}, V_{GEN} = 10\text{ V}$ $R_G = 25\ \Omega$  (Switching time is essentially independent of operating temperature)	3		8	ns	
	$t_r$		2		8		
Turn-Off Time	$t_{d(OFF)}$		13		18		
	$t_f$		9		12		

- NOTES: 1.  $T_A = 25^\circ\text{C}$  unless otherwise noted.  
 2. For design aid only, not subject to production testing.  
 3. Pulse test;  $PW = 300\ \mu\text{s}$ , duty cycle  $\leq 2\%$ .